AiT Semiconductor Inc.

SWITCHING DIODE FORWARD VOLTAGE 1.25V CURRENT 150mA RECOVERY

DESCRIPTION

The 1N4448W is available in SOD-123 package.

FEATURE

- Fast Switching Speed
- Surface Mount Package Ideally Suited For Automatic Insertion
- For General Purpose Switching Applications
- **High Conductance**

MECHANICAL DATA

- Case: SOD-123
- Surface Mount Fast Switching Diode

PIN DESCRIPTION



SOD-123

ORDERING INFORMATION



Package Type	Part Number			
SOD-123	1N4448W			
Note	SPQ: 3,000pcs/Reel			
AiT provides all RoHS Compliant Products				

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DESCRIPTION				
CATHODE				
ANODE				

TYPICAL PERFORMANCE CHARACTERISTICS

Fig 1. Forward Characteristics

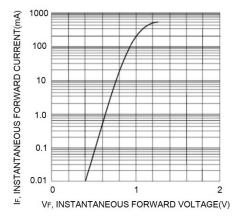
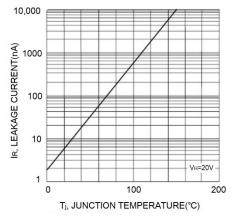


Fig 2. Leakage Current vs. Junction Temperature





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ABSOLUTE MAXIMUM RATINGS

T _a = 25°C, unless otherwise specified		
V _{RM} , Non-Repetitive Peak Reverse Volt	100V	
V _{RRM} , Peak Repetitive Reverse Voltage	75V	
V _{RWM} , Working Peak Reverse Voltage	75V	
V _R , DC Reverse Voltage	75V	
V _{R(RMS)} , RMS Reverse Voltage	53V	
IFM, Forward Continuous Current	500mA	
I _o , Average Rectified Output Current		250mA
IFSM, Non-Repetitive Peak Forward	t=1.0µs	4A
Surge Current	t=1.0s	2A
P _d , Power Dissipation*	·	350mW
R _{0JA} , Thermal Resistance Junction to Ambient Air		357°C/W
T _J , Junction Temperature Range	-65°C ~ + 150°C	
T _{STG} , Storage Temperature Range	-65°C ~ + 150°C	

Stresses above may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions beyond those indicated in the Electrical Characteristics are not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

ELECTRICAL CHARACTERISTICS

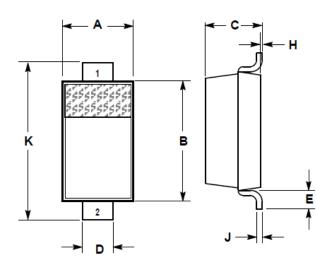
$T_A = 25^{\circ}C$, unless otherwise specified

Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Reverse Breakdown Voltage	V(_{BR)R}	I _R =1.0μA	75	-	-	V
Forward Voltage	V _{F1}	l⊧=5mA	0.620	-	0.720	
	V_{F2}	I _F =10mA	-	-	0.855	N/
	V _{F3}	I _F =100mA	-	-	1.000	V
	VF4	I⊧=150mA	-	-	1.250	
	I _{R1}	V _R =75V	-	-	2.5	μA
Reverse Current	I _{R2}	V _R =20V	-	-	25	nA
Capacitance Between Terminals	Ст	V _R = 0, f = 1MHz	-	-	4	pF
Reverse Recovery Time	t _{rr}	$I_{\rm F} = I_{\rm R} = 10 {\rm mA},$	-	-	4	ns
		Irr=0.1 x I _R , R _L = 100Ω				

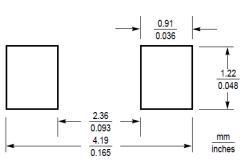


PACKAGE INFORMATION

Dimension in SOD-123 Package



Suggest Solder Pad Layout



DIM	INCHES		MILLIMETERS		
	MIN	MAX	MIN	MAX	
А	0.055	0.071	1.40	1.80	
В	0.100	0.112	2.55	2.85	
С	0.037	0.053	0.95	1.35	
D	0.020	0.028	0.50	0.70	
E	0.004	-	0.25	-	
Н	0.000	0.004	0.00	0.10	
J	-	0.006	-	0.15	
К	0.140	0.152	3.55	3.85	



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